

# BLF8G20LS-400PV; BLF8G20LS-400PGV

Power LDMOS transistor

Rev. 5 — 1 September 2015

AMPLEON

Product data sheet

## 1. Product profile

### 1.1 General description

400 W LDMOS power transistor with improved video bandwidth for base station applications at frequencies from 1805 MHz to 1995 MHz.

**Table 1. Typical performance**

Typical RF performance at  $T_{case} = 25\text{ °C}$  in a common source class-AB production test circuit, tested on straight lead device.

Test signal	f (MHz)	$I_{Dq}$ (mA)	$V_{DS}$ (V)	$P_{L(AV)}$ (W)	$G_p$ (dB)	$\eta_D$ (%)	ACPR <sub>5M</sub> (dBc)
2-carrier W-CDMA	1805 to 1995	3400	28	95	19	28	-33 <a href="#">[1]</a>

[1] Test signal: 3GPP test model 1; 64 DPCH; PAR = 7.5 dB at 0.01 % probability on CCDF; carrier spacing = 5 MHz;  $f_1 = 1807.5\text{ MHz}$ ;  $f_2 = 1812.5\text{ MHz}$ ;  $f_3 = 1872.5\text{ MHz}$ ;  $f_4 = 1877.5\text{ MHz}$ .

### 1.2 Features and benefits

- Decoupling leads to enable improved Video BandWidth (VBW) (120 MHz typical)
- High efficiency
- Low thermal resistance providing excellent thermal stability
- Designed for broadband operation
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent pre-distortability
- Internally matched for ease of use
- Integrated ESD protection
- Design optimized for gull-wing
- Excellent ruggedness
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

### 1.3 Applications

- RF power amplifiers for base stations and multi carrier applications in the 1805 MHz to 1995 MHz frequency range

## 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
<b>BLF8G20LS-400PV (SOT1242B)</b>			
1	drain1		
2	drain2		
3	gate1		
4	gate2		
5	source <a href="#">[1]</a>		
6	decoupling1		
7	decoupling2		
8	n.c.		
9	n.c.		
<b>BLF8G20LS-400PGV (SOT1242C)</b>			
1	drain1		
2	drain2		
3	gate1		
4	gate2		
5	source <a href="#">[1]</a>		
6	decoupling1		
7	decoupling2		
8	n.c.		
9	n.c.		

[1] Connected to flange.

## 3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BLF8G20LS-400PV	-	earless flanged ceramic package; 8 leads	SOT1242B
BLF8G20LS-400PGV	-	earless flanged ceramic package; 8 leads	SOT1242C

## 4. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage		-	65	V
$V_{GS}$	gate-source voltage		-0.5	+13	V
$T_{stg}$	storage temperature		-65	+150	°C
$T_j$	junction temperature	[1]	-	225	°C

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the on-line MTF calculator.

## 5. Thermal characteristics

**Table 5. Thermal characteristics**

Symbol	Parameter	Conditions	Typ	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	$T_{case} = 80\text{ °C}; P_L = 80\text{ W}$	0.23	K/W

## 6. Characteristics

**Table 6. DC characteristics**

$T_j = 25\text{ °C}$ ; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0\text{ V}; I_D = 3.0\text{ mA}$	65	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$V_{DS} = 10\text{ V}; I_D = 300\text{ mA}$	1.5	1.9	2.3	V
$I_{DSS}$	drain leakage current	$V_{GS} = 0\text{ V}; V_{DS} = 28\text{ V}$	-	-	3.0	μA
$I_{DSX}$	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75\text{ V}; V_{DS} = 10\text{ V}$	-	51.5	-	A
$I_{GSS}$	gate leakage current	$V_{GS} = 11\text{ V}; V_{DS} = 0\text{ V}$	-	-	300	nA
$g_{fs}$	forward transconductance	$V_{DS} = 10\text{ V}; I_D = 15\text{ A}$	-	20.6	-	S
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75\text{ V}; I_D = 10.5\text{ A}$	-	0.055	-	Ω

**Table 7. RF characteristics**

Test signal: 2-carrier W-CDMA; PAR = 7.5 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1-64 DPCH;  $f_1 = 1807.5\text{ MHz}; f_2 = 1812.5\text{ MHz}; f_3 = 1872.5\text{ MHz}; f_4 = 1877.5\text{ MHz}$ ; RF performance at  $V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}; T_{case} = 25\text{ °C}$ ; unless otherwise specified; in a class-AB production test circuit, tested on straight lead device.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$G_p$	power gain	$P_{L(AV)} = 95\text{ W}$	17.8	19	-	dB
$RL_{in}$	input return loss	$P_{L(AV)} = 95\text{ W}$	-	-12	-6	dB
$\eta_D$	drain efficiency	$P_{L(AV)} = 95\text{ W}$	24	28	-	%
$ACPR_{5M}$	adjacent channel power ratio (5 MHz)	$P_{L(AV)} = 95\text{ W}$	-	-33	-28	dBc

## 7. Test information

### 7.1 Ruggedness in class-AB operation

The BLF8G20LS-400PV and BLF8G20LS-400PGV are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS} = 28\text{ V}$ ;  $I_{Dq} = 3300\text{ mA}$ ; 2-carrier W-CDMA signal;  $P_L = 200\text{ W}$ ;  $f_c = 1800\text{ MHz}$ ; 5 MHz spacing, 46 % clipping.

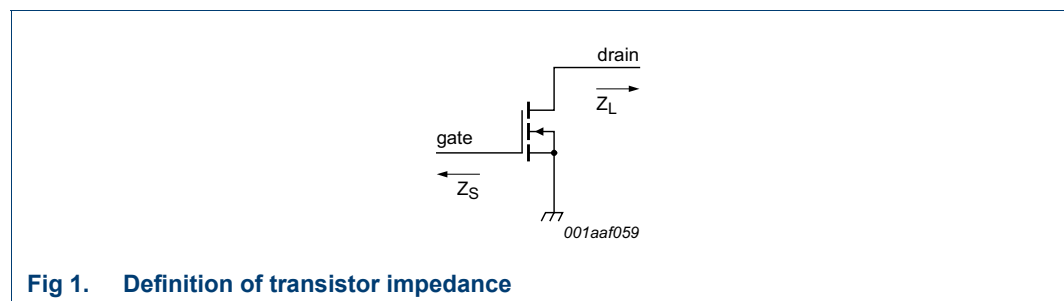
### 7.2 Impedance information

**Table 8. Typical impedance for the top-half of the push-pull package**

Measured load-pull data;  $I_{Dq} = 1800\text{ mA}$ ;  $V_{DS} = 28\text{ V}$ ;  $T_{case} = 25\text{ °C}$ , water cooled.

f (MHz)	$Z_S$ <sup>[1]</sup> ( $\Omega$ )	$Z_L$ <sup>[1]</sup> ( $\Omega$ )
<b>BLF8G20LS-400PV (straight lead)</b>		
1800	4.1 – j4.66	4.1 – j4.5
1840	5.2 – j3.6	4.4 – j4.4
1880	4.6 – j1.45	4.85 – j4.25
1930	2.8 – j0.3	4.5 – j4.3
1960	2.1 – j0.5	5.5 – j3.5
1990	1.56 – j0.6	5.5 – j3.4
<b>BLF8G20LS-400PGV (gull-wing)</b>		
1800	3.7 – j7.6	4.2 – j6.8
1840	4.34 – j6.1	4.4 – j6.7
1880	4.75 – j5.2	4 – j6.4
1930	3.17 – j3.4	4.6 – j6.5
1960	2 – j3.05	5.8 – j5.5
1990	2.5 – j2.6	5.8 – j5.7

[1]  $Z_S$  and  $Z_L$  defined in [Figure 1](#).

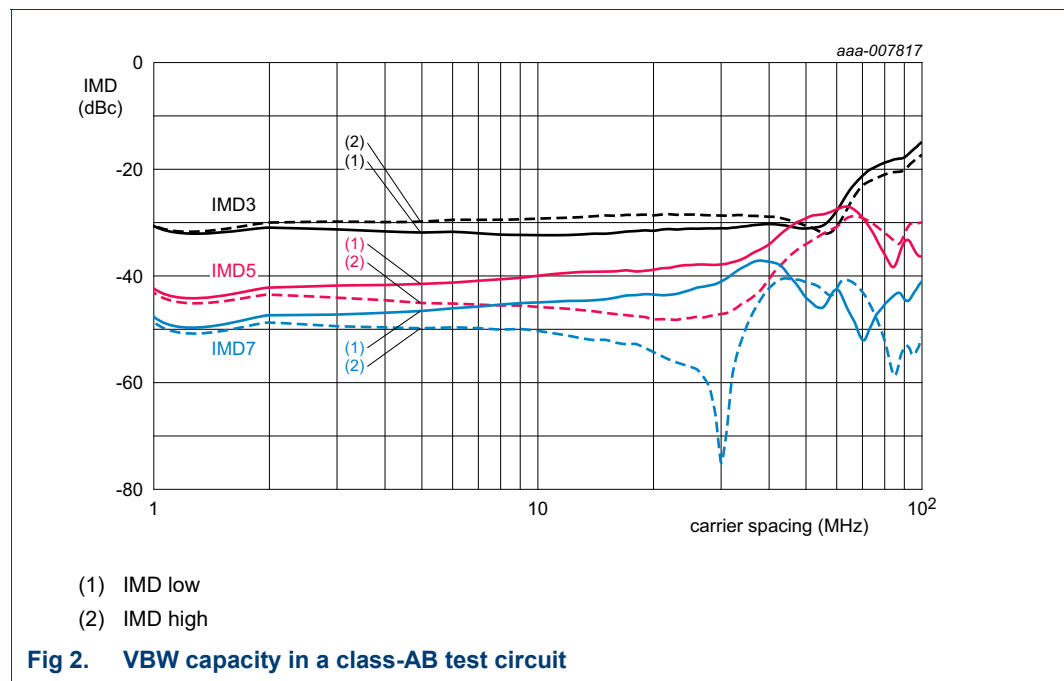


**Fig 1. Definition of transistor impedance**

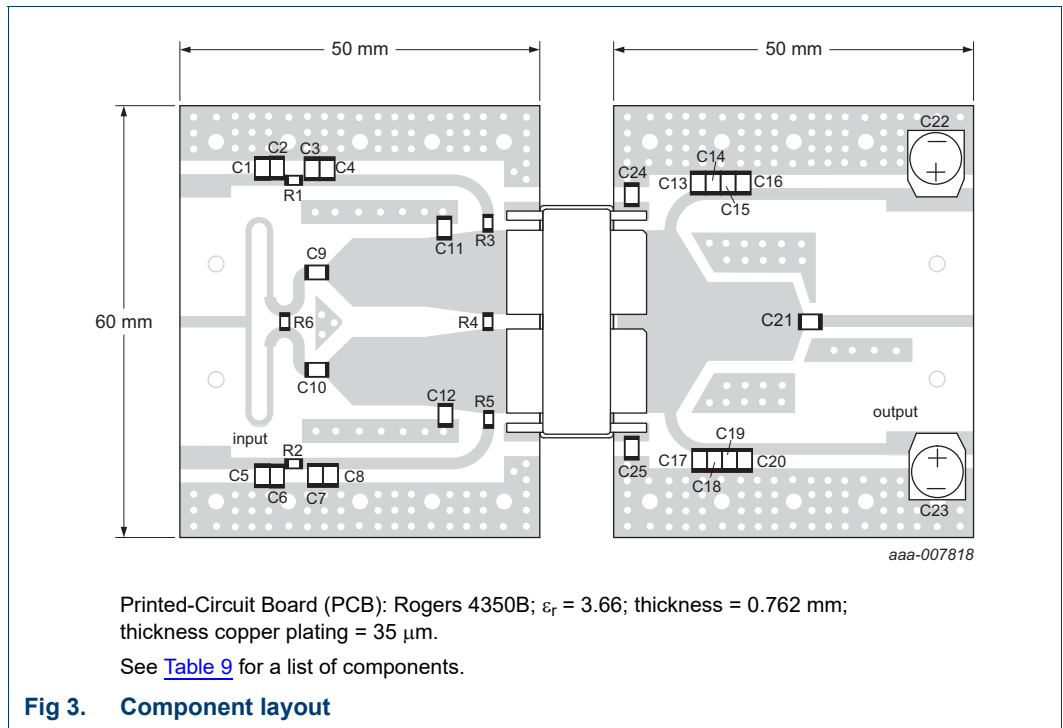
### 7.3 VBW in class-AB operation

The BLF8G20LS-400PV and BLF8G20LS-400PGV have a video bandwidth of 120 MHz (typical) when measured in a class-AB test circuit operating in the 1800 MHz to 1880 MHz frequency band for  $V_{DS} = 28\text{ V}$  and  $I_{Dq} = 3.3\text{ A}$ , where the VBW is defined as the location of the resonance in the base-band impedance measurement obtained using a low-frequency probe.

The VBW measurement based on the 2-tone IMD test as a function of carrier spacing is shown below.



7.4 Test circuit



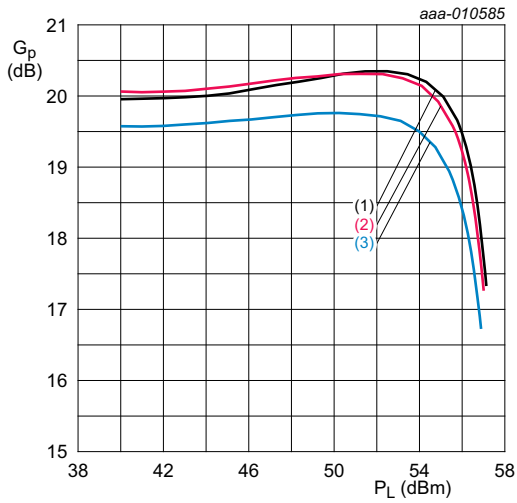
**Table 9. List of components**

See [Figure 3](#) for component layout.

Component	Description	Value	Remarks
C1, C5, C16, C20	multilayer ceramic chip capacitor	10 $\mu\text{F}$ , 50 V	Murata, SMD 2220
C2, C6, C15, C19, C24, C25	multilayer ceramic chip capacitor	4.7 $\mu\text{F}$ , 50 V	Murata
C3, C7, C14, C18	multilayer ceramic chip capacitor	1 nF	ATC100B
C4, C8, C9, C10, C13, C17, C21	multilayer ceramic chip capacitor	24 pF	ATC100B
C11, C12	multilayer ceramic chip capacitor	100 pF	ATC100B
C22, C23	electrolytic capacitor	2200 $\mu\text{F}$ , 63 V	
R1, R2	resistor	10 $\Omega$	SMD 1206
R3, R5	resistor	5.1 $\Omega$	SMD 1206
R4	resistor	33 $\Omega$	SMD 1206
R6	resistor	100 $\Omega$	SMD 1206

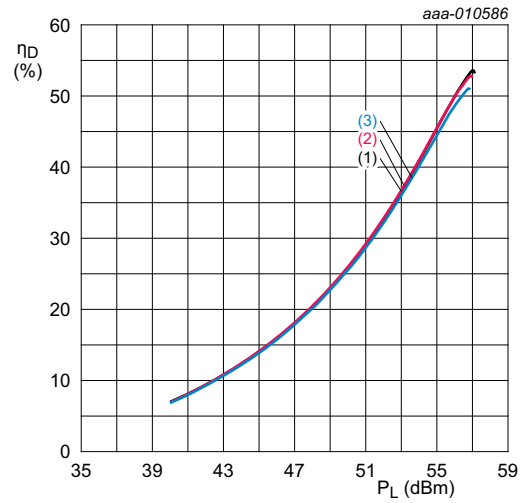
7.5 Graphical data

7.5.1 Pulsed CW



$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}; t_p = 100\text{ }\mu\text{s}; \delta = 10\text{ }\%$ .  
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

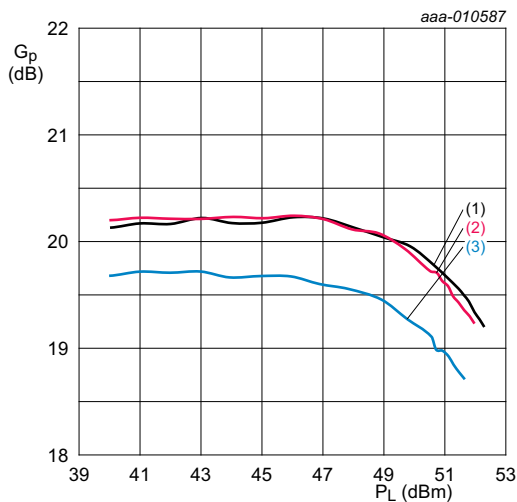
**Fig 4. Power gain as a function of output power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}; t_p = 100\text{ }\mu\text{s}; \delta = 10\text{ }\%$ .  
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

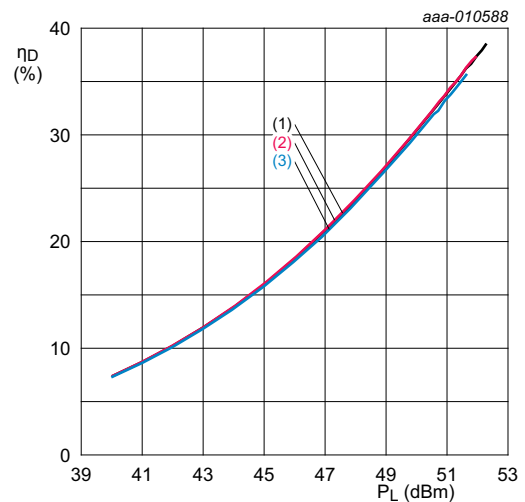
**Fig 5. Drain efficiency as a function of output power; typical values**

7.5.2 IS-95



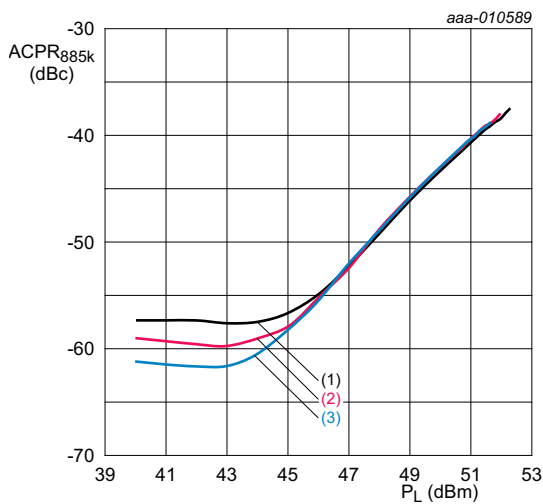
$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}$ .  
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

**Fig 6. Power gain as a function of output power; typical values**



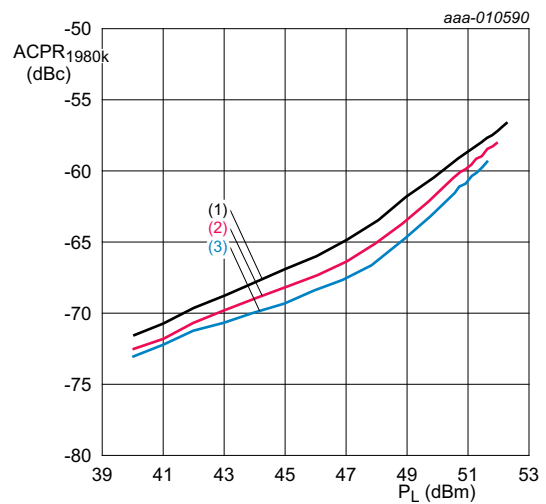
$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}$ .  
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

**Fig 7. Drain efficiency as a function of output power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}$ .  
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

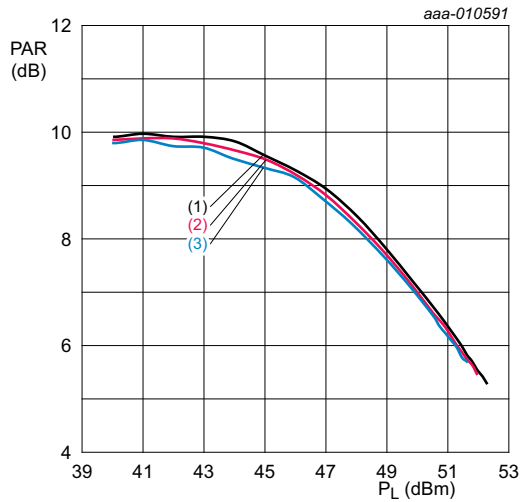
**Fig 8. Adjacent channel power ratio (885 kHz) as a function of output power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}$ .  
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

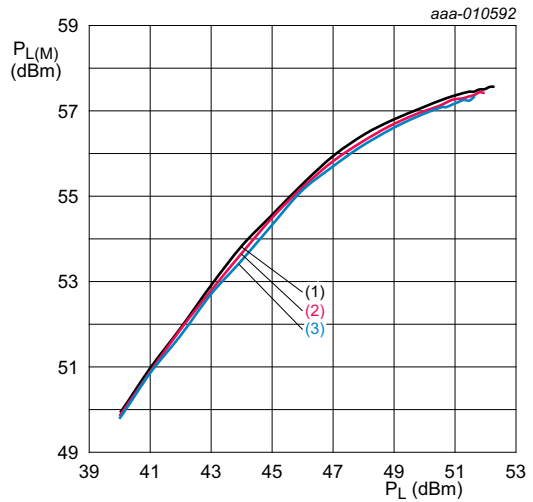
**Fig 9. Adjacent channel power ratio (1980 kHz) as a function of output power; typical values**





$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}.$   
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

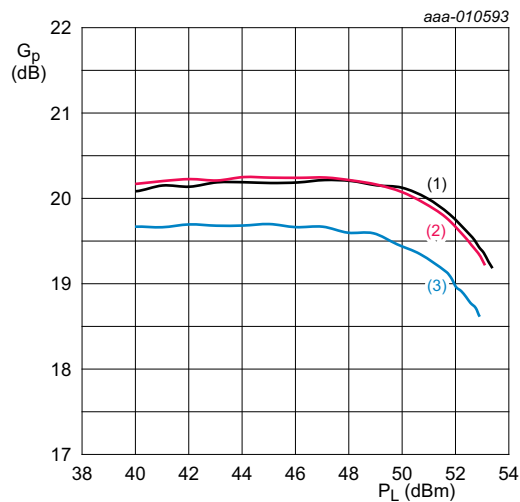
**Fig 10. Peak-to-average ratio as a function of output power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}.$   
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

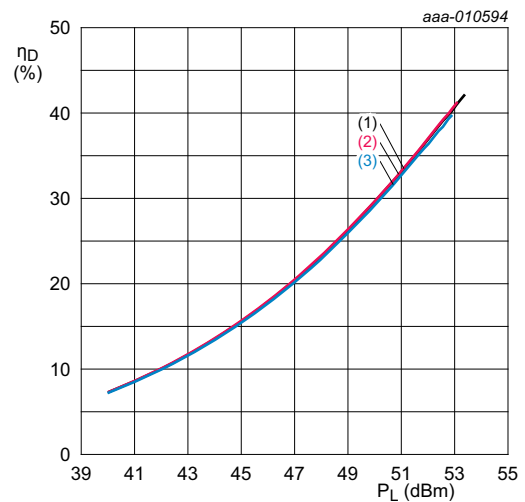
**Fig 11. Peak output power as a function of output power; typical values**

7.5.3 1-Carrier W-CDMA



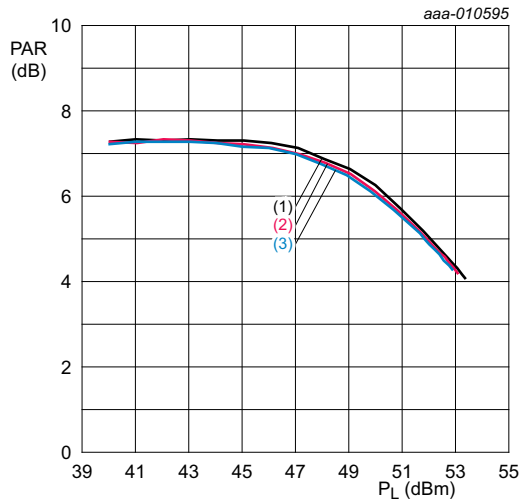
$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}.$   
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

**Fig 12. Power gain as a function of output power; typical values**



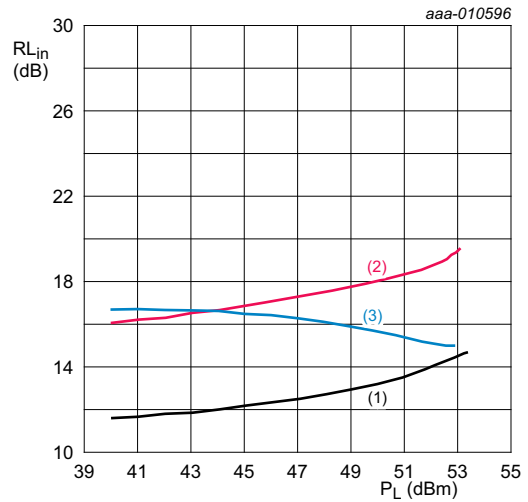
$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}.$   
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

**Fig 13. Drain efficiency as a function of output power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}.$   
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

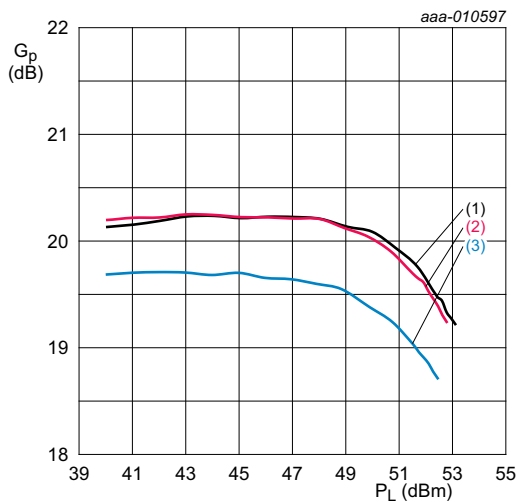
**Fig 14. Peak-to-average ratio as a function of output power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}.$   
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

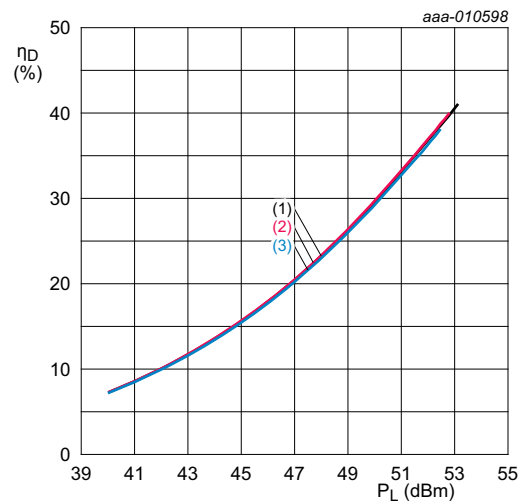
**Fig 15. Input return loss as a function of output power; typical values**

7.5.4 2-Carrier W-CDMA



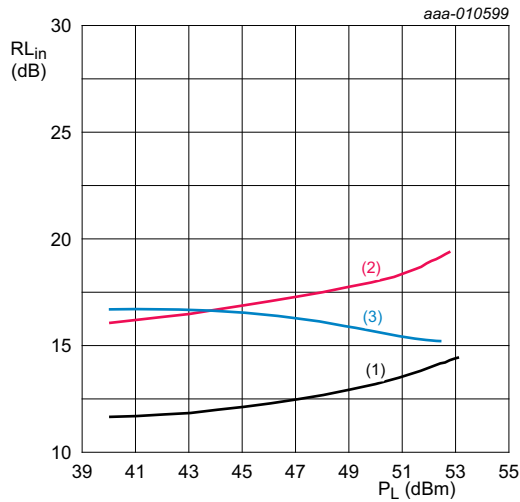
$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}.$   
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

**Fig 16. Power gain as a function of output power; typical values**



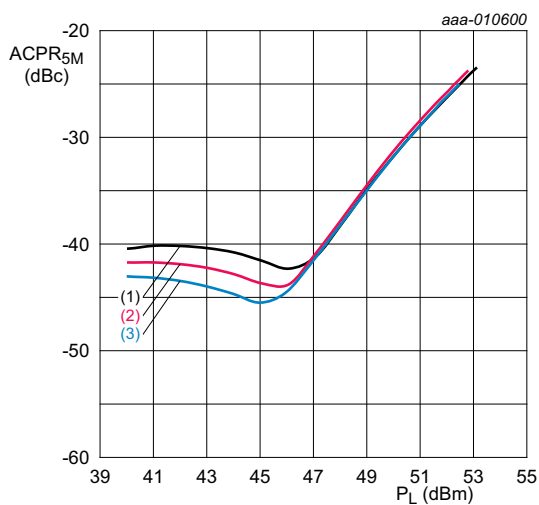
$V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA}.$   
 (1)  $f = 1805\text{ MHz}$   
 (2)  $f = 1840\text{ MHz}$   
 (3)  $f = 1880\text{ MHz}$

**Fig 17. Drain efficiency as a function of output power; typical values**



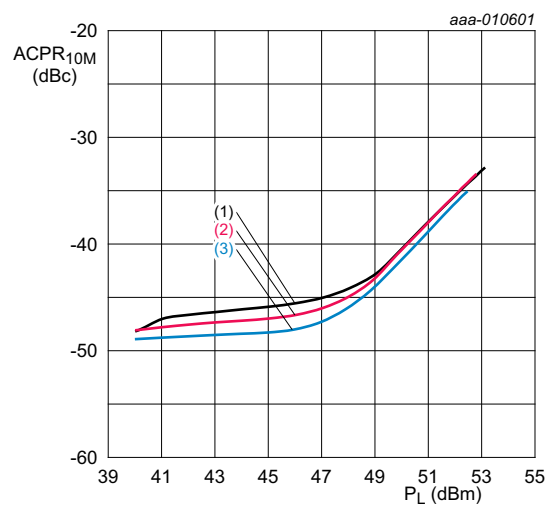
- $V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA.}$
- (1)  $f = 1805\text{ MHz}$
  - (2)  $f = 1840\text{ MHz}$
  - (3)  $f = 1880\text{ MHz}$

**Fig 18. Input return loss as a function of output power; typical values**



- $V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA.}$
- (1)  $f = 1805\text{ MHz}$
  - (2)  $f = 1840\text{ MHz}$
  - (3)  $f = 1880\text{ MHz}$

**Fig 19. Adjacent channel power ratio (5 MHz) as a function of output power; typical values**



- $V_{DS} = 28\text{ V}; I_{Dq} = 3400\text{ mA.}$
- (1)  $f = 1805\text{ MHz}$
  - (2)  $f = 1840\text{ MHz}$
  - (3)  $f = 1880\text{ MHz}$

**Fig 20. Adjacent channel power ratio (10 MHz) as a function of output power; typical values**

8. Package outline

Earless flanged ceramic package; 8 leads

SOT1242B

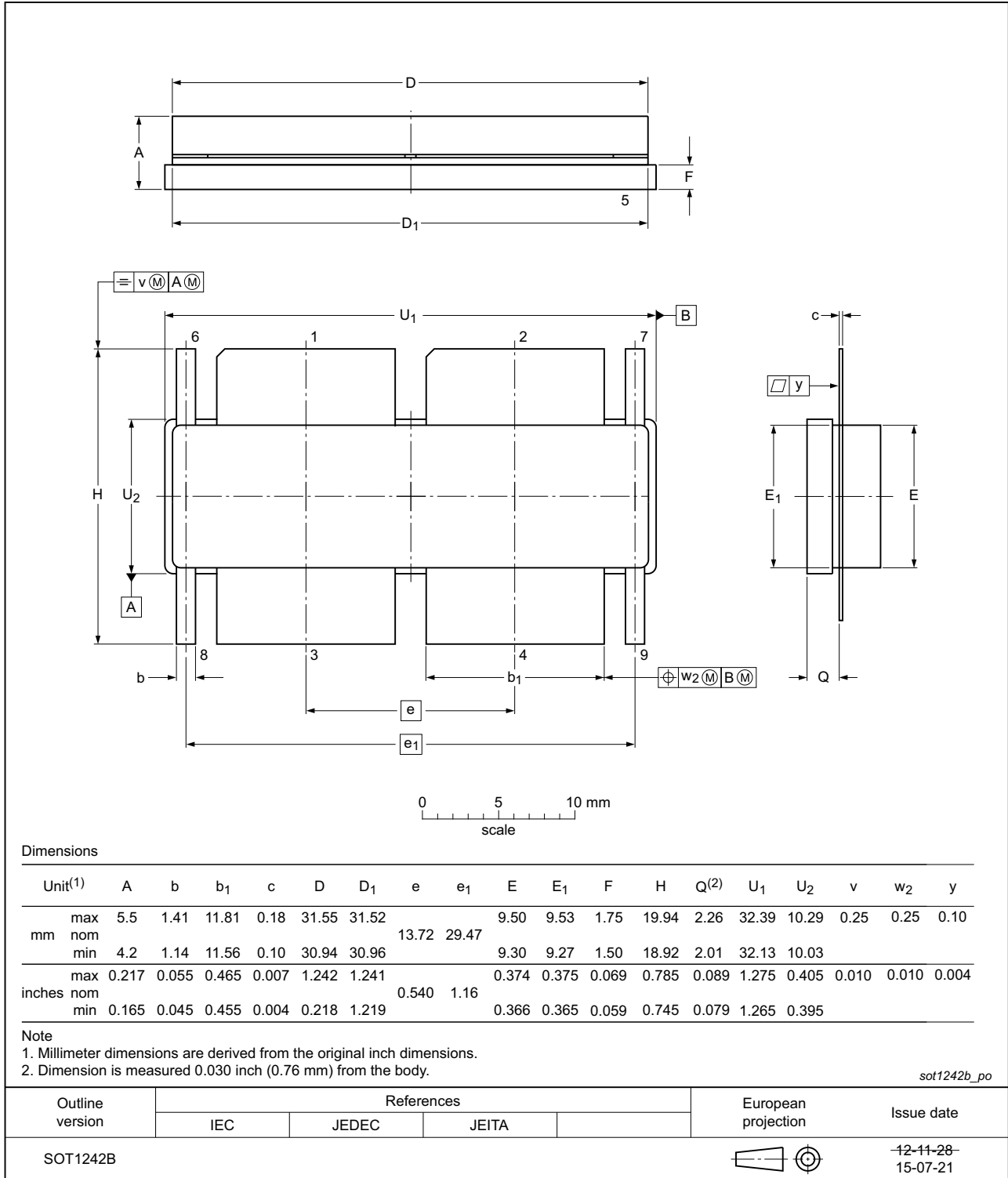


Fig 21. Package outline SOT1242B

Earless flanged ceramic package; 8 leads

SOT1242C

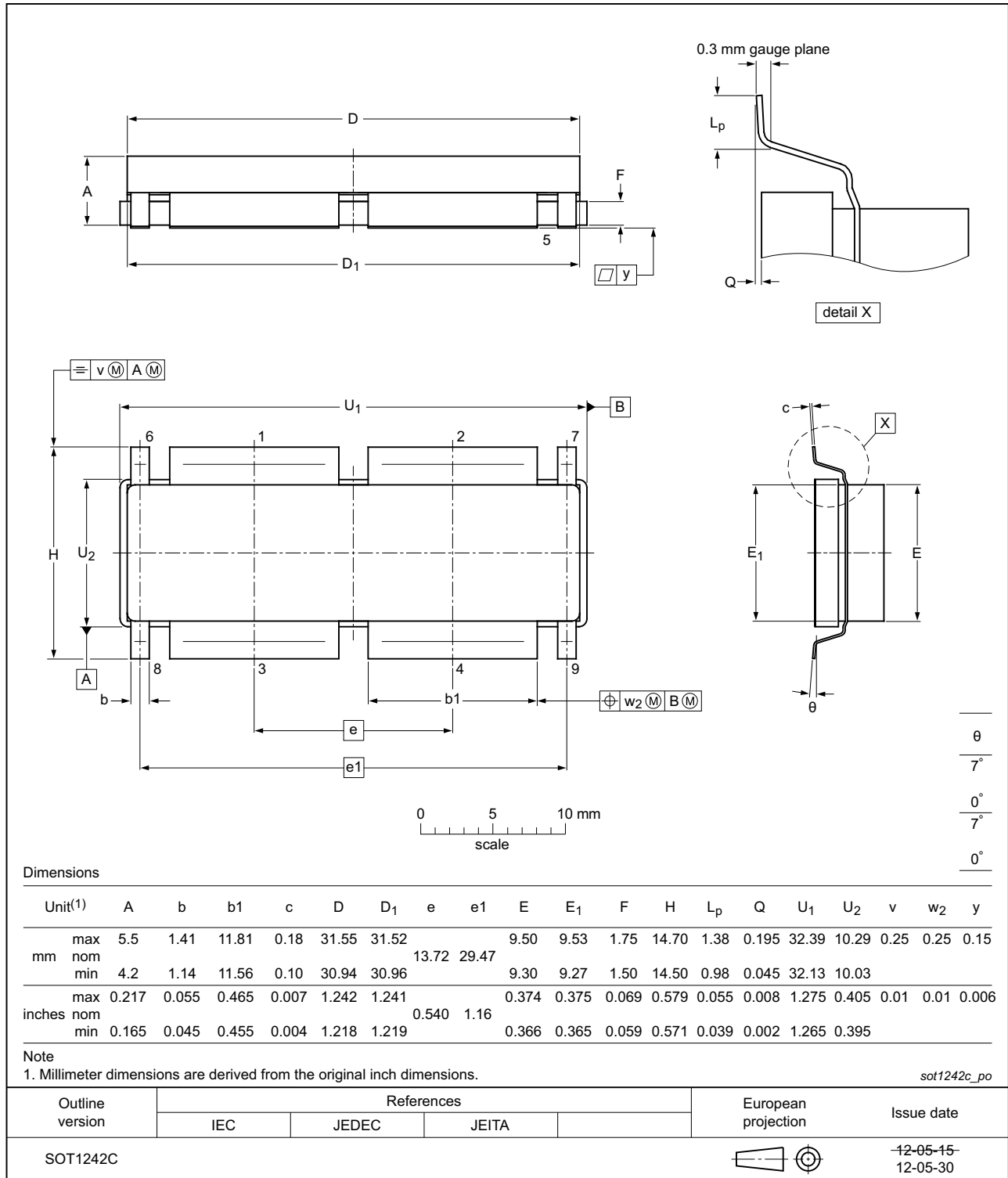


Fig 22. Package outline SOT1242C

## 9. Handling information

### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

## 10. Abbreviations

Table 10. Abbreviations

Acronym	Description
3GPP	3rd Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical Channel
ESD	ElectroStatic Discharge
IMD	InterModulation Distortion
IS-95	Interim Standard 95
LDMOS	Laterally Diffused Metal Oxide Semiconductor
MTF	Median Time to Failure
PAR	Peak-to-Average Ratio
SMD	Surface Mounted Device
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

## 11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF8G20LS-400PV_LS-400PGV#5	20150901	Product data sheet		BLF8G20LS-400PV_LS-400PGV v.4
Modifications:		<ul style="list-style-type: none"> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>		
BLF8G20LS-400PV_LS-400PGV v.4	20150728	Product data sheet	-	BLF8G20LS-400PV_LS-400PGV v.3
BLF8G20LS-400PV_LS-400PGV v.3	20140603	Product data sheet	-	BLF8G20LS-400PV_LS-400PGV v.2
BLF8G20LS-400PV_LS-400PGV v.2	20130625	Product data sheet	-	BLF8G20LS-400PV_LS-400PGV v.1
BLF8G20LS-400PV_LS-400PGV v.1	20130606	Preliminary data sheet	-	-

## 12. Legal information

### 12.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.ampleon.com>.

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